

## Product Features

- Stratum 3 performance with hold-over stability (0.32 ppm) over industrial temperature range (-40 °C to +85 °C)
- Available in both 10 and 4/5 pads configurations
- 3.0 V, 3.3 V and 5.0 V versions
- Low phase noise and Excellent G-Sens performance: 1.5ppb/G
- Tri-state Function available



## Product Description

MtronPTI's M610x Series TCXO's and TCVCXO's provide network and wireless engineers with low voltage, surface mount products with tight stability over temperature and time. MtronPTI's unique approach to crystal compensation enables these devices to achieve full Stratum 3 temperature stability including holdover over -40 C to +85 C. Specially processed crystals enable the M610x to achieve consistent long-term stability and minimal frequency shift after reflow. This processing also achieves excellent g-sensitivity (1.5 ppb/g). The low phase noise (-155 dBc/Hz at 100 kHz) makes the M610x ideal for those design engineers working on high data-rate, low BER data communication network products. With two standard package configurations, MtronPTI can support the original industry standard 10 pad as well as the newer 4/5 pad topology (4 pad is without Tristate function and 5 pad is with Tristate function).

## Product Applications

The M610x Series is ideally suited for a wide range of applications such as SONET, SDH, SERDES, GSM, CDMA, 3G, 4G, Gig-Ethernet, 10G and 40G systems. Standard output for the M610x series is HCMOS compatible or clipped sinewave and draws as little as 1.5 mA with a 3.3 volt supply at 13 MHz. This low power consumption provides a distinct advantage over similarly specified ovenized oscillators for power-sensitive remote applications. The M610x series offers  $\pm 9.2$  ppm minimum pull range with excellent tuning linearity performance for critical PLL applications. This series is available in frequencies from 8 to 40MHz and selectively to 52MHz.

## Product Ordering Information

Ordering Information		M610x	1	S	T	C	N	00.0000 MHz
<b>Product Series</b>	_____	_____	_____	_____	_____	_____	_____	_____
<b>M6100:</b>	5.0 V							
<b>M6101:</b>	3.3 V							
<b>M6102:</b>	3.0 V							
<b>Temperature Range</b>	_____	_____	_____	_____	_____	_____	_____	_____
1:	0°C to +70°C							
2:	-40°C to +85°C							
6:	-20°C to +70°C							
8:	0°C to +50°C							
F:	-30°C to +75°C							
<b>Stability</b>	_____	_____	_____	_____	_____	_____	_____	_____
S:	$\pm 4.6$ ppm w/ Holdover							
<b>Output Type</b>	_____	_____	_____	_____	_____	_____	_____	_____
T:	Voltage Controlled With Tristate							
F:	No Voltage Control With Tristate							
<b>Output Waveform</b>	_____	_____	_____	_____	_____	_____	_____	_____
C:	HCMOS							
S:	Clipped Sine Wave							
<b>Package/Lead Configurations</b>	_____	_____	_____	_____	_____	_____	_____	_____
N:	10 Pad Leadless Ceramic							
T:	4/5 Pad Leadless Ceramic							
<b>Frequency (customer specified)</b>	_____	_____	_____	_____	_____	_____	_____	_____

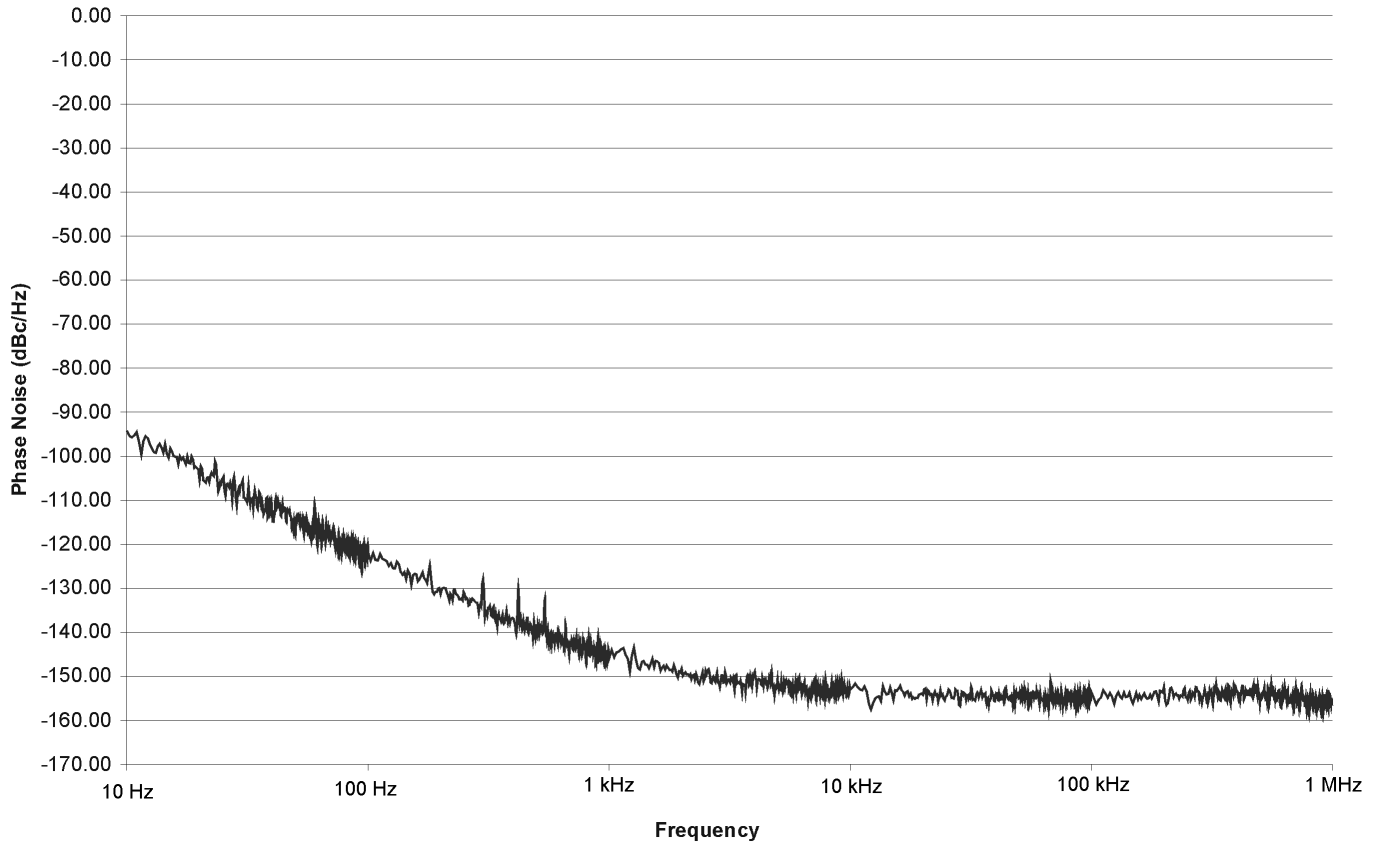
M6100Sxxx, M6101Sxxx & M6102Sxxx - Contact factory for datasheets.

### Performance Characteristics

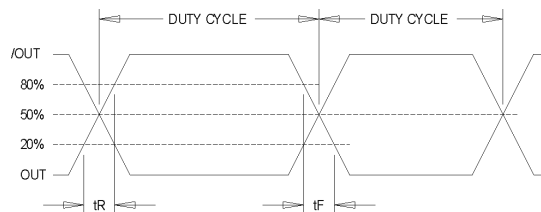
Parameter	Symbol	Min.	Typ.	Max.	Units	Conditions/Notes
Frequency Range	F <sub>O</sub>	8		52	MHz	Contact factory above 40 MHz
Operating Temperature	T <sub>A</sub>	-40		+85	°C	See Ordering Information
Storage Temperature	T <sub>STG</sub>	-55		+125	°C	
Frequency Tolerance @ +25°C		-1.0		+1.0	ppm	For TCXO only
Frequency Stability		-0.28		+0.28	ppm	Stability vs. Temperature
		-4.6		+4.6	ppm	Overall stability for 10 years
		-0.32		+0.32	ppm	Holdover stability for 24 hours over operating temperature
Stability Vs. Reflow		-1.0		+1.0	ppm	
Frequency Vs. Supply			±0.02	±0.1	ppm	For 5% supply voltage variation
Frequency Vs. Load			±0.02	±0.1	ppm	For 5% load variation
Supply Voltage Tolerance		-5.0		+5.0	%	See Ordering Information
Supply Current (I <sub>D</sub> )			2.2	3.3	mA	HCMOS output at 13 MHz
			3.5	5.0	mA	HCMOS output at 26 MHz
			6.0	9.2	mA	HCMOS output at 52 MHz
			1.5	2.2	mA	Clipped sinewave output at 13 MHz
			1.8	2.7	mA	Clipped sinewave output at 26 MHz
			3.0	4.5	mA	Clipped sinewave output at 52 MHz
Output Logic Levels (HCMOS)	V <sub>OL</sub> V <sub>OH</sub>			20	%V <sub>S</sub> %V <sub>S</sub>	I <sub>OH</sub> /I <sub>OL</sub> = ± 4 mA, V <sub>S</sub> = +3.0 V I <sub>OH</sub> /I <sub>OL</sub> = ± 4 mA, V <sub>S</sub> = +3.0 V
Output Level (Clipped Sinewave)		1.0			V <sub>pk-pk</sub> V <sub>pk-pk</sub>	F <sub>O</sub> ≤ 40 MHz F <sub>O</sub> > 40 MHz
Waveform Symmetry		40		60	%	Ref. to ½ V <sub>S</sub> . HCMOS only
Rise/Fall Time				8	ns	Ref. 10% to 90%. HCMOS only
Output Load			15 10/10		pF Kohm/pF	HCMOS output Clipped sinewave output
Frequency Adjustment		±9.2			ppm	Over Control Voltage Range
Control Voltage Range		0.3		2.7	Volts	For V <sub>S</sub> = 3.0
		0.3		3.0	Volts	For V <sub>S</sub> = 3.3
		0.5		4.5	Volts	For V <sub>S</sub> = 5.0
Input Leakage Current		-50		+50	µA	
Input Resistance		100			Kohm	
Linearity				3	%	
Modulation Bandwidth		2			kHz	
Tristate Function		70			%V <sub>S</sub>	Output enabled. Logic "1" or "Open"
				30	%V <sub>S</sub>	Output disabled. Logic "0" or "GND"
Tristate Leakage Current		-100		+100	µA	
Phase Noise (Typical 10 MHz CMOS)			-95		dBc/Hz	10 Hz Offset
			-125		dBc/Hz	100 Hz Offset
			-145		dBc/Hz	1 KHz Offset
			-152		dBc/Hz	10 KHz Offset
			-155		dBc/Hz	100 kHz Offset
Environmental	Shock	MIL-STD-202, Method 213, Condition C				100 g
	Vibration	MIL-STD-202, Methods 201 & 204				10 g from 10 to 2000 Hz
	Solderability	EIAJ-STD-002				
	Package	5.0 x 7.0 x 2.0 mm, SMT				RoHS Compliant
	Max Soldering Conditions	See solder profile				

**Phase Noise Plot**

M610x 10MHz Phase Noise



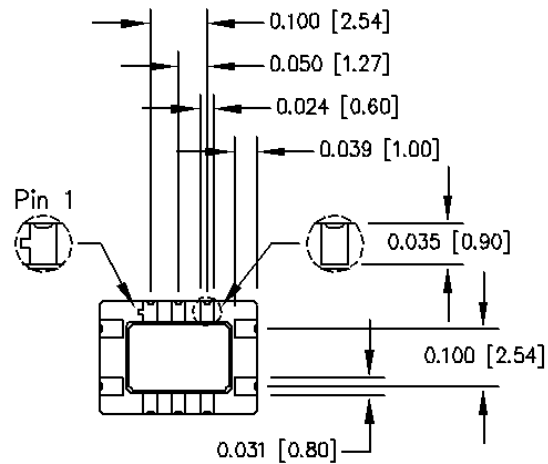
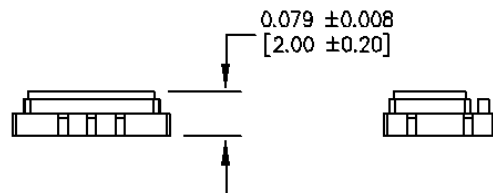
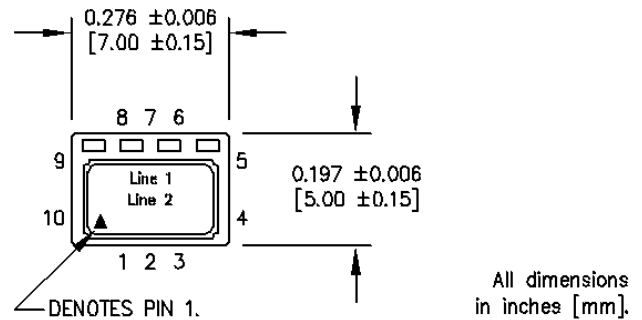
**Output Waveform (HCMOS Output)**



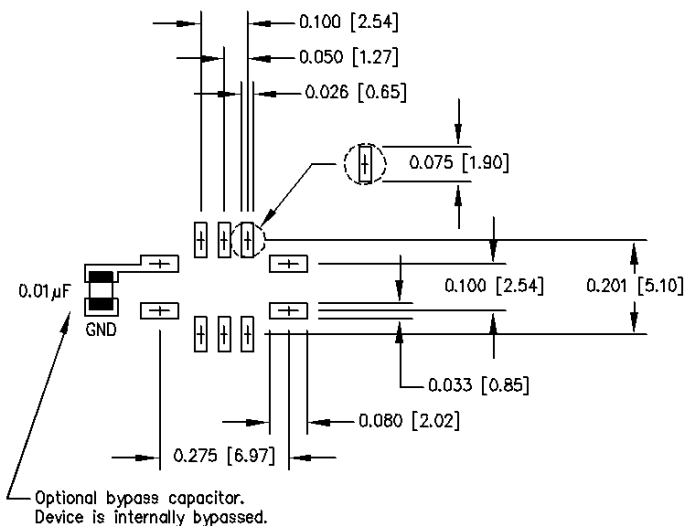
**Product Dimension & Pinout Information - Package Code N (10 Pad)**

Pin Connections	
Function	Pad
Vref or N/C	1
N/C - Do Not Connect	2
N/C - Do Not Connect	3
Ground	4
Output	5
N/C - Do Not Connect	6
N/C - Do Not Connect	7
Tristate	8
Supply Voltage (V <sub>s</sub> )	9
Control Voltage	10

Part Marking Guide	
Line	Description
1	Part family, year, month of production
2	Frequency



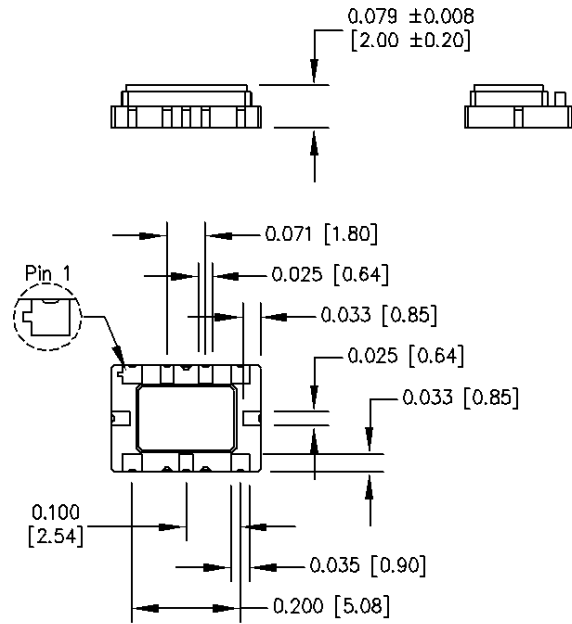
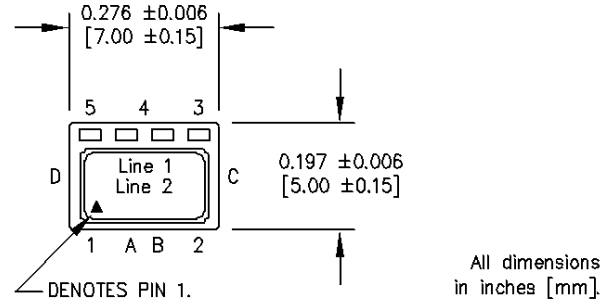
**SUGGESTED SOLDER PAD LAYOUT**



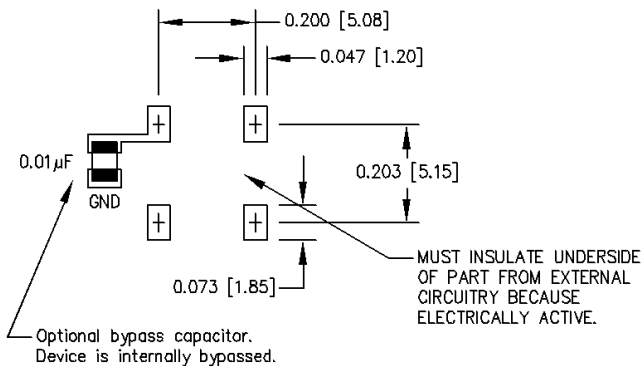
**Product Dimension & Pinout Information - Package Code T (4/5 Pad)**

Pin Connections	
Function	Pad
Vcontrol	1
N/C - Do Not Connect	A
N/C - Do Not Connect	B
Ground	2
N/C - Do Not Connect	C
Output	3
Tristate or N/C - Do Not Connect	4
Power	5
N/C - Do Not Connect	D

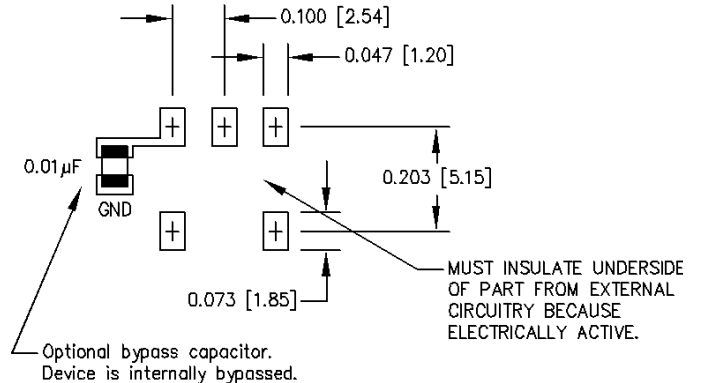
Part Marking Guide	
Line	Description
1	Part family, year, month of production
2	Frequency



**SUGGESTED SOLDER PAD LAYOUT WITHOUT TRISTATE (4 PAD)**



**SUGGESTED SOLDER PAD LAYOUT WITH TRISTATE (5 PAD)**



## Handling Information

Although protection circuitry has been designed into the M610x oscillator, proper precautions should be taken to avoid exposure to electrostatic discharge (ESD) during handling and mounting. MtronPTI utilizes a human-body model (HBM) and a charged-device model (CDM) for ESD-susceptibility testing and protection design evaluation. ESD voltage thresholds are dependent on the circuit parameters used to define the mode. Although no industry-wide standard has been adopted for the CDM, a standard HBM (resistance = 1500 Ω, capacitance = 100 pF) is widely used and therefore can be used for comparison purposes. The HBM ESD threshold presented here was obtained using these circuit parameters.

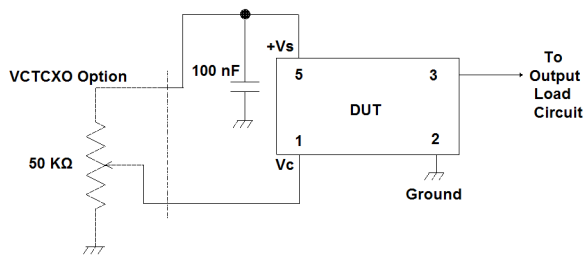
Model	ESD Threshold, Minimum	Unit
Human Body	1500*	V
Charged Device	1500*	V

\* MIL-STD-883D, Method 3015, Class 1

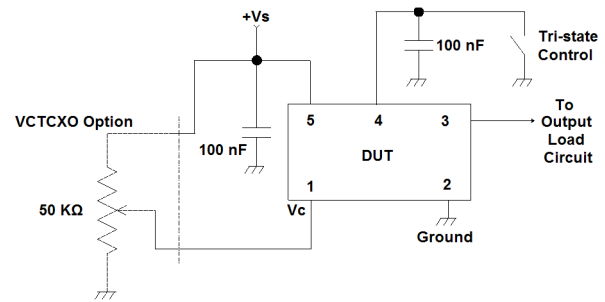


**ATTENTION**  
Static Sensitive  
Devices  
Handle only at  
Static Safe Work  
Stations

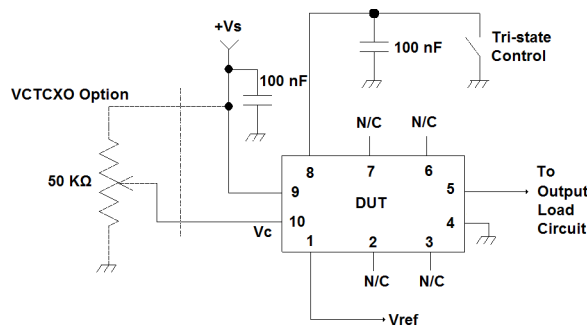
## Typical Test Circuits



Test Circuit - T Package  
Without Tri-State Option



Test Circuit - T Package  
With Tri-State Option



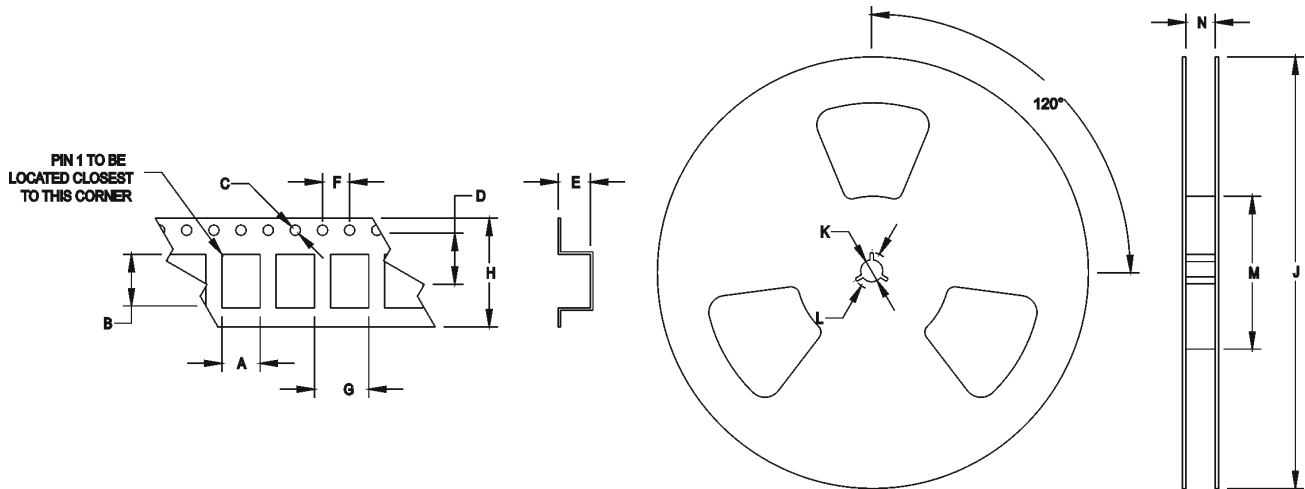
Test Circuit - N Package  
With Tri-State

## M610x Series Stratum 3

5 x 7 mm, 3.0, 3.3 & 5.0 Volt, HCMOS or Clipped Sinewave, Precision TCXO/TCVCXO

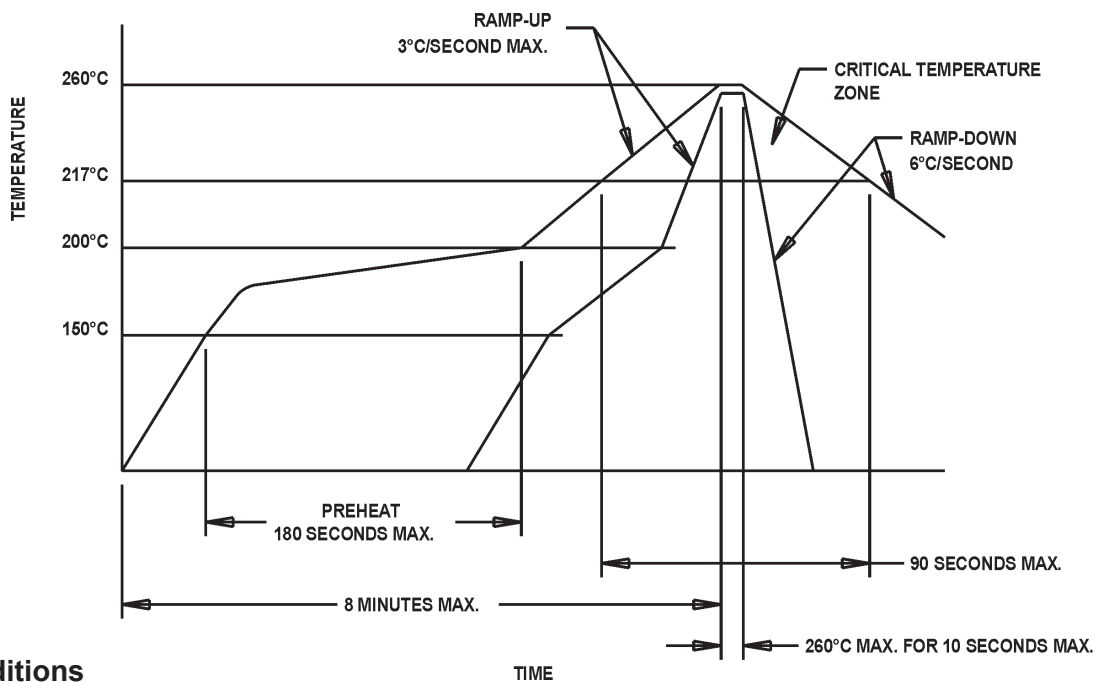
### Tape & Reel Specifications

(all measurements are in mm)	A	B	C	D	E	F	G	H	J	K	L	M	N
M610x	5.40	7.40	1.55	7.50	2.60	2.00	4.00	16.00	330	13.00	20.20	100	16.40



Standard Tape and Reel: 1000 parts per reel

### Maximum Soldering Conditions



### Solder Conditions

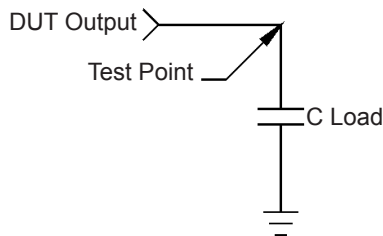
Note: Exceeding these limits may damage the device.

**Quality Parameters**

Environmental Specifications/Qualification Testing Performed on the M610x TCXO/TCVCXO		
Test	Test Method	Test Condition
Electrical Characteristics	Internal Specification	Per Specification
Frequency vs. Temperature	Internal Specification	Per Specification
Mechanical Shock	MIL-STD-202, Method 213, C	100 g, 6 ms
Vibration	MIL-STD-202, Method 201-204	10 g from 10-2000 Hz
Thermal Cycle	MIL-STD-883, Method 1010, B	-55 Deg. C to +125 Deg. C, 15 minute Dwell, 10 cycles
Aging	Internal Specification	168 Hours at 105 Degrees C
Gross Leak	MIL-STD-202, Method 112	30 Second Immersion (Crystal Only)
Fine Leak	MIL-STD-202, Method 112	Must meet $1 \times 10^{-8}$ (Crystal Only)
Solderability	MIL-STD-883, Method 2003	8 Hour Steam Age – Must Exhibit 95% coverage
Resistance to Solvents	MIL-STD-883, Method 2015	Three 1 minute soaks
Physical Dimensions	MIL-STD-883, Method 2016	Per Specification
Internal Visual	Internal Specification	Per Internal Specification

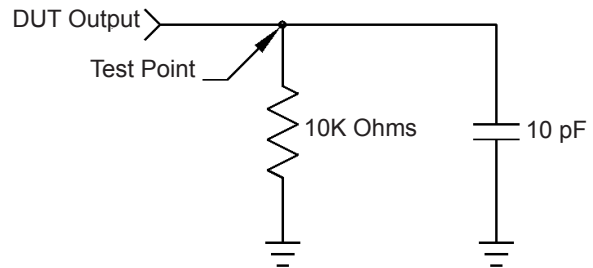
**Load Circuit**

Load Circuit #2 - HCMOS Output



Note: C Load includes probe and fixturing.

Load Circuit #7 - Clipped Sinewave Output



**Product Revision Table**

Date	Revision	PCN Number	Details of Revision

For custom products or additional specifications contact our sales team at  
**800.762.8800 (toll free) or 605.665.9321**

For more information on this product visit the MtronPTI website at  
**[www.mtronpti.com](http://www.mtronpti.com)**